

## **General Description**

The WSF30100 is the highest performance trench N-ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSF30100 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

#### **Features**

Advanced high cell density Trench technology Super Low Gate Charge Excellent CdV/dt effect decline 100% EAS Guaranteed Green Device Available

## **Product Summery**

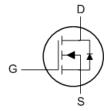
| BVDSS | RDSON | ID   |
|-------|-------|------|
| 30V   | 2.5mΩ | 100A |

## **Applications**

- High Frequency Point-of-Load Synchronous Buck Converter
- Networking DC-DC Power System
- Power Tool Application

## **TO-252 Pin Configuration**





# **Absolute Maximum Ratings**

| Symbol                               | Parameter  | Rating | Units      |
|--------------------------------------|--|--------|------------|
| $V_{DS}$                             | Drain-Source Voltage   | 30     | V          |
| $V_{GS}$                             | Gate-Source Voltage  | ±20    | V          |
| I <sub>D</sub> @T <sub>C</sub> =25℃  | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1,7</sup> | 100    | Α          |
| I <sub>D</sub> @T <sub>C</sub> =100℃ | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1,7</sup> | 80     | А          |
| I <sub>DM</sub>                      | Pulsed Drain Current <sup>2</sup>                              | 310    | А          |
| EAS                                  | Single Pulse Avalanche Energy <sup>3</sup>                     | 378    | mJ         |
| I <sub>AS</sub>                      | Avalanche Current 70.2   |        | Α          |
| P <sub>D</sub> @T <sub>C</sub> =25°C | Total Power Dissipation <sup>4</sup>                           | 89.3   | W          |
| T <sub>STG</sub>                     | Storage Temperature Range -55 to 175                           |        | $^{\circ}$ |
| TJ                                   | Operating Junction Temperature Range -55 to 175                |        | $^{\circ}$ |

### **Thermal Data**

| Symbol         | Parameter  | Тур. | Max. | Unit |
|----------------|--|------|------|------|
| $R_{	heta JA}$ | Thermal Resistance Junction-Ambient <sup>1</sup> |      | 62   | °C/W |
| $R_{	heta JC}$ | Thermal Resistance Junction-Case <sup>1</sup>    |      | 1.4  | °C/W |



## Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

| Symbol                               | Parameter                                      | Conditions  | Min.  | Тур.  | Max. | Unit |
|--------------------------------------|--|---|-------|-------|------|------|
| BV <sub>DSS</sub>                    | Drain-Source Breakdown Voltage                 | V <sub>GS</sub> =0V , I <sub>D</sub> =250uA                       | 30    |       | V    |      |
| $\triangle BV_{DSS}/\triangle T_{J}$ | BV <sub>DSS</sub> Temperature Coefficient      | Reference to 25℃ , I <sub>D</sub> =1mA                            |       | 0.022 |      | V/°C |
| В                                    | Static Drain-Source On-Resistance <sup>2</sup> | V <sub>GS</sub> =10V , I <sub>D</sub> =20A                        |       | 2.5   | 3    | mΩ   |
| R <sub>DS(ON)</sub>                  |  | V <sub>GS</sub> =10V , I <sub>D</sub> =15A                        |       | 3.2   | 4    |      |
| $V_{GS(th)}$                         | Gate Threshold Voltage                         | \/ -\/   -2500A   | 1     | 1.5   | 2.5  | V    |
| △V <sub>GS(th)</sub>                 | V <sub>GS(th)</sub> Temperature Coefficient    | $V_{GS}=V_{DS}$ , $I_D=250uA$                                     |       | -6.1  |      | mV/℃ |
|                                      | Drain Source Leakage Current                   | V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25℃  |       |       | 2    | - uA |
| I <sub>DSS</sub>                     | Drain-Source Leakage Current                   | V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55℃  |       |       | 10   |      |
| I <sub>GSS</sub>                     | Gate-Source Leakage Current                    | $V_{GS}=\pm 20 V$ , $V_{DS}$ =0 $V$                               |       |       | ±100 | nA   |
| gfs                                  | Forwar Trd ansconductance                      | V <sub>DS</sub> =5V , I <sub>D</sub> =30A                         |       | 60    |      | S    |
| Rg                                   | Gate Resistance                                | V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz                |       | 0.9   | 1.8  | Ω    |
| $Q_g$                                | Total Gate Charge (4.5V)                       | V <sub>DS</sub> =15V , V <sub>GS</sub> =10V , I <sub>D</sub> =20A |       | 56.9  |      |      |
| $Q_gs$                               | Gate-Source Charge                             |   |       | 13.8  |      | nC   |
| $Q_gd$                               | Gate-Drain Charge                              |   |       | 23.5  |      |      |
| T <sub>d(on)</sub>                   | Turn-On Delay Time                             |   |       | 20.1  |      |      |
| T <sub>r</sub>                       | Rise Time                                      | V <sub>DD</sub> =15V , V <sub>GS</sub> =10V ,                     |       | 6.3   |      |      |
| T <sub>d(off)</sub>                  | Turn-Off Dela Ty ime                           | $R_G=3.3\Omega$ , $I_D=1A$ 12                                     | 124.6 |       | ns   |      |
| T <sub>f</sub>                       | TFall ime                                      |   |       | 15.8  |      |      |
| C <sub>iss</sub>                     | Input Capacitance                              |   |       | 5935  |      |      |
| C <sub>oss</sub>                     | Output Capacitance                             | V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz               |       | 725   |      | pF   |
| C <sub>rss</sub>                     | Reverse Transfer Capacitance                   |   |       | 538   |      |      |

#### **Guaranteed Avalanche Characteristics**

| Symbol | Parameter                                  | Conditions  | Min. | Тур. | Max. | Unit |
|--------|--|---|------|------|------|------|
| EAS    | Single Pulse Avalanche Energy <sup>5</sup> | V <sub>DD</sub> =25V , L=0.1mH , I <sub>AS</sub> =20A | 69   |      |      | mJ   |

#### **Diode Characteristics**

| Symbol          | Parameter                                | Conditions   | Min. | Тур. | Max. | Unit |
|-----------------|--|--|------|------|------|------|
| I <sub>S</sub>  | Continuous Source Current <sup>1,6</sup> | V <sub>G</sub> =V <sub>D</sub> =0V , Force Current         |      |      | 40   | Α    |
| I <sub>SM</sub> | Pulsed Source Current <sup>2,6</sup>     |  |      |      | 310  | Α    |
| V <sub>SD</sub> | Diode Forward Voltage <sup>2</sup>       | $V_{GS}$ =0 $V$ , $I_{S}$ = $A$ , $T_{J}$ =25 $^{\circ}$ C |      |      | 1.2  | V    |

#### Note:

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper,t<10sec.
- 2.The data tested by pulsed , pulse width  $\leq 300 us$  , duty cycle  $\leq 2\%$
- 3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =20A
- 4. The power dissipation is limited by 150°C junction temperature
- 5.The Min. value is 100% EAS tested guarantee.
- 6. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.
- 7. Package limitation current is 100A.



## **Typical Characteristics**

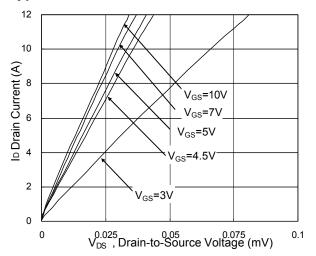


Fig.1 Typical Output Characteristics

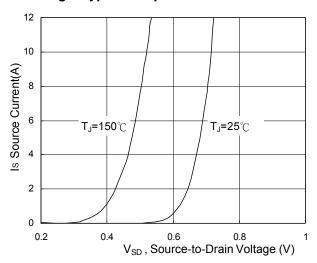


Fig.3 Forward Characteristics of Reverse

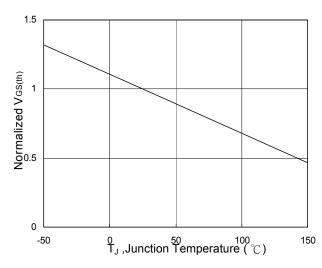


Fig.5 Normalized V<sub>GS(th)</sub> v.s T<sub>J</sub>

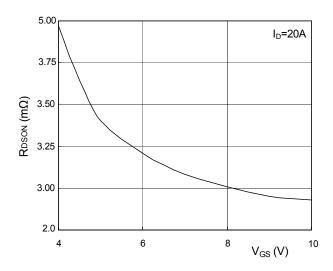


Fig.2 On-Resistance v.s Gate- Source

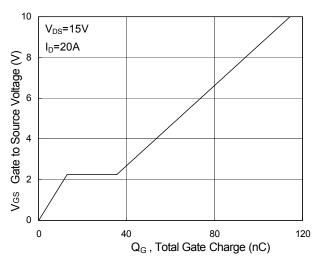


Fig.4 Gate-Charge Characteristics

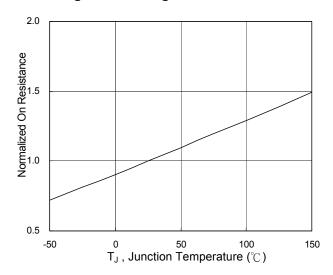
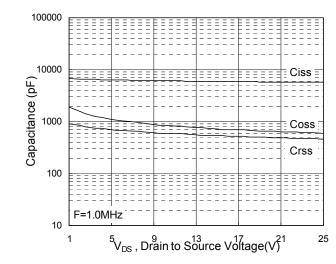


Fig.6 Normalized R<sub>DSON</sub> v.s T<sub>J</sub>





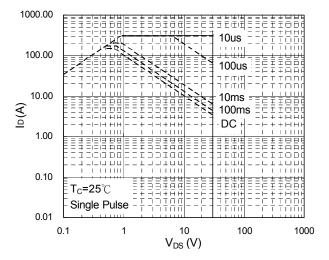
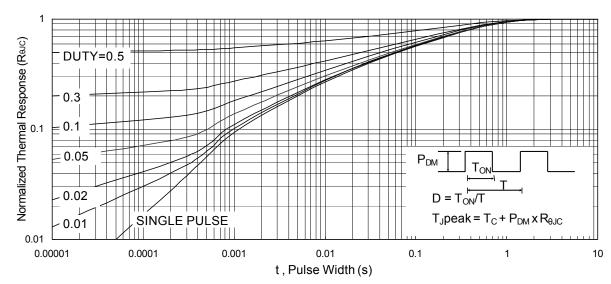


Fig.7 Capacitance

Fig.8 Safe Operating Area



**Fig.9 Normalized Maximum Transient Thermal** 

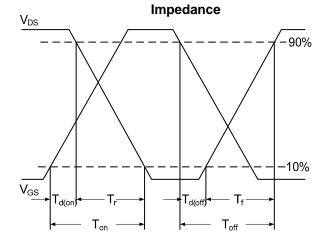


Fig.10 Switching Time Waveform

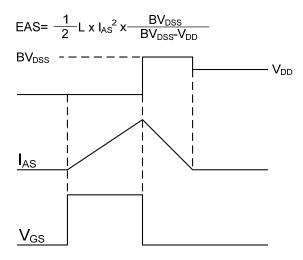


Fig.11 Unclamped Inductive Waveform



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